CMOS Voltage Regulator With ON/OFF Switch

3A

PRODUCT DESCRIPTION



MD7673 series are highly accurate, lownoise, high power supply rejection ratio (PSRR), low-dropout voltage

regulator (LDO) with high output current capability manufactured in CMOS processes. It can deliver up to 3A of current while consuming 40µA of quiescent current. Internal circuitry includes a reference voltage generator, an error amplifier, driver transistor, circuit, over-current protection short-circuit protection circuit, thermal shutdown circuit and a phase compensation circuit. The MD7673 operates by default as a fixed output voltage regulator (default output voltage: 5V) while usage of an external resistor divider allows adjustable out voltages as low as 0.7V. Additional features include enable function, power good flag and output noise reduction pin.

APPLICATIONS

- Smart wearer
- Long-life battery-powered devices
- Portable mobile devices, such as mobile phones, cameras, and so on
- Wireless communication equipment

FEATURES

Highly Accurate: ±2%

Low Quiescent Current: 40μA

Dropout Voltage: 350mV@3A

Maximum Output Current: 3A

Input Voltage Range: 2~6V

Output Voltage Noise: 115µVrms@Vouт=3.3V

High PSRR:61dB@1kHz

Temperature Stability: ±100ppm/°C

ON/OFF Logic = Enable High

Power Good and Enable Functions

Standby Current: 10nA

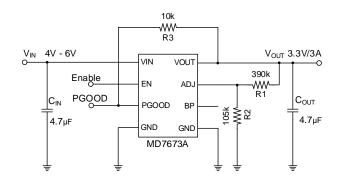
C_{OUT} Discharge Circuit when EN Disable is Active

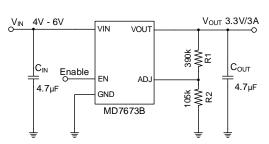
 Protections Circuits: Current Limit, Short Circuit, and Thermal Protections

 Output Capacitor: Low ESR Ceramic Capacitor Compatible

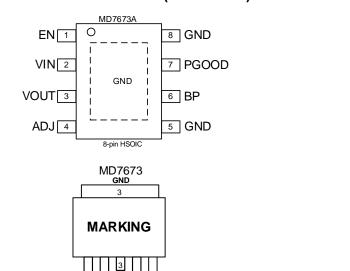
RoHS compliant "Green"/Halogen Free 8-pin
 Exposed pad SOIC (HSOP8), 5-pin TO263 and
 4-pin TO252 packages

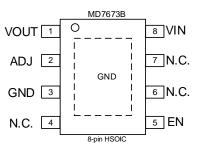
TYPICAL APPLICATION CIRCUIT:

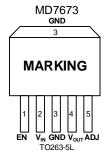




PIN CONFIGURATION (TOP VIEW)







PRODUCT SELECTIONS

Туре	Fixed Output Voltage(note 1*)	ADJ	Accuracy (note 2*)	Package (note 3*)	MARKING (note 4*)
MD7673A50SF4	5V	Yes	±2%	HSOP8	№ 7673A
MD7673B50SF4	5V	Yes	±2%	HSOP8	№ 7673B
MD7673E50UB2	5V	Yes	±2%	TO252-4L	№ 7673
MD7673E50VC1	5V	Yes	±2%	TO263-5L	№ 7673

Notes:

- 1* Customer can request to customize the output voltage ranged from 1.2V to 5V if desired voltage is not found in the selections.
- 2^{\star} Customer can request customization of accuracy requirement.
- 3* Customer can request customization of package choice.
- 4* Please pay attention to the MARKING of the product package type.

PIN DESCRIPTION

Name	HSOP8 (MD7673A)	HSOP8 (MD7673B)	TO252-4L (MD7673)	TO263-5L (MD7673)	Description	
VOUT	3	1	4	4	Regulator Output pin.	
ADJ	4	2	5	5	Adjustable Pin. Output Voltage can be set by external feedback resistors when using a resistive divider. Or, connect ADJ to GND for Vout = 5V, set by internal feedback resistors.	
GND	5,8	3	3	3	Ground Signal	
EN	1	5	1	1	Enable Pin. Minimum 1.6V to enable the device. Maximum 0.4V to shutdown the device.	
VIN	2	8	2	2	Power Input Pin. Must be closely decoupled to GND pin with a 4.7µF or greater ceramic capacitor.	
BP	6	-	-	-	Bypass pin. Connect a 1µF capacitor to GND to reduce output noise. Bypass pin can be left floating if unnecessary.	
PGOOD	7	-	-	-	Power Good open Drain Output	
N.C.	-	4,6,7	-	-	None Connection (Used to connect GND or OPEN state.)	
GND	Exposed Pad	Exposed Pad	-	-	Connect to GND.	

ABSOLUTE MAXIMUM RATINGS

(Unless otherwise indicated: Ta=25 $^{\circ}\mathrm{C}$)

PARAMETER	SYMBOL	RATINGS		UNITS	
Input Voltage	V _{IN}	-0.3 ~ 7		\/	
Output Voltage	Vout	-0.3 ~ V _{IN} +0.3		V	
Power Dissipation	PD	Interna	Internally Limited		
Thermal Resistance	Re.iB ⁽¹⁾	HSOP8	80	°C/W	
Thermal Resistance	K θJB(··/	TO252-5	60	C/VV	
Operating Ambient Temperature	T _{opr}	-40 ~	+85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	T _{stg}	-40 ~	+125		
ESD Protection	ESD HBM	40	00	V	

Note: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.

⁽¹⁾ Mounted on JEDEC standard 4layer (2s2p) PCB test board

ELECTRICAL CHARACTERISTICS

Unless otherwise indicated, $V_{IN} = V_{OUT} + 1V$, $C_{IN} = 4.7 \mu F$, $C_{OUT} = 4.7 \mu F$, $C_{BYP} = 1 \mu F$, $T_J = 25 ^{\circ}C$.

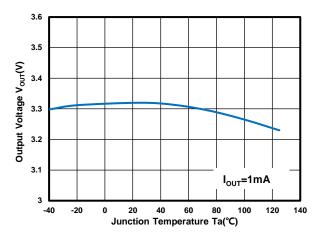
Continuous Output Current Continuous Output Voltage Tolerance Vour(s) Vin Vin	PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Output Voltage Tolerance Vout(s) lour=1mA -2 +2 % Continuous Output Current lour V.N≥2.3V 3 A A Ground Current IoND VENEVIN, no load 40 µA Shutdown Current Ishut VeneVIN, lour=100mA 390 µA Output Current Limit ILIM 4 A Current Fold Back 1 A A Dropout Voltage² VENEVIN, Vout<3V lour=3N			CONDITIONS		111.			
Continuous Output Current Iout Vin>2.3V 3 A Ground Current I _{GND} Vin>VenVin, no load 40 µA Shutdown Current Issurt Ven=0 0.01 µA Output Current Limit Ium 4 A Current Fold Back Ven=0 0.01 µA Dropout Voltage*2 Ven=Vin, Vout*3V 360 mV Line Regulation Ven=Vin, Vout*3V 360 mV Line Regulation Ven=Vin, Vout*3V 350 mV Load Regulation ΔVout*3 350 mV Temperature Stability ΔVout*3 Ven*Ven*Vout*3Vin*Ven*Ven*Sel*V 3 15 mV Temperature Stability ΔVout*3 Ven*Ven*Vout*Sel*Vin*Ven*Ven*Sel*V 3 15 mV Temperature Stability ΔVout*3 Ven*Ven*Ven*Ven*Ven*Ven*Sel*Vout*Sel*Ven*Ven*Sel*Ven*Ven*Ven*Sel*Ven*Ven*Ven*Sel*Ven*Ven*Ven*Ven*Ven*Ven*Ven*Ven*Ven*Ven	<u> </u>		1 4 4					
Ground Current Gr		` '				+2		
Shutdown Current Shut Ven=Vin, Iour=100mA 390 μA	Continuous Output Current	Іоит		3	40		А	
Shutdown Current	Ground Current	I_{GND}	V _{EN} =V _{IN} , no load				μA	
Output Current Limit Ium 4 A Current Fold Back Vere Vin, Vour < 3V lour = 3A	Chutdown Current	1					-	
Current Fold Back Vene Voltage '2 Vene Voltage '3 Vene Voltage '3 1 A Line Regulation Vone Voltage *10 or = 3A 350 mV Line Regulation Vout(s) + 1V ≤ Vin = Ven ≤ 6V lour = 1mA 3 15 mV Load Regulation ΔVout Vin = Ven = Vout(s) + 1.0V mAslour ≤ 3A 15 mV Temperature Stability ΔVout Vin = Ven = Vout(s) + 1.0V lour = 1mA vin = 1.0V lour = 1			VEN=U				μA	
Dropout Voltage '2 Vorce Vorce		ILIM					Α	
Dropout Voltage Volt	Current Fold Back							
VeN=VN, Vour≥3V Iour=3A Iour=1mA	Dropout Voltage*2	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \			360		mV	
Load Regulation	Dropout voitage ²	V DROP			350		1 1111	
Load Regulation ΔVout2 ImA≤lour≤3A 15 25 fill Temperature Stability $ \frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} $ $ \frac{V_{IN}=V_{EN}=V_{OUT}(s)+1.0V}{V_{IOUT}=1mA} $ $ \frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} $ $ \frac{V_{IN}=V_{EN}=V_{OUT}(s)+1.0V}{V_{IOUT}=1mA} $ $ \frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} $ $ \frac{V_{IN}=V_{EN}=V_{OUT}(s)+1.0V}{V_{IOUT}=1mA} $ $ \frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} $ $ \frac{V_{IN}=V_{EN}=V_{OUT}(s)+1.0V}{V_{IOUT}=1mA} $ $ \frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} $ $ \frac{V_{IN}=V_{EN}=V_{OUT}(s)+1.0V}{V_{IOUT}=1mA} $ $ \frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} $ $ \frac{V_{IN}=V_{EN}=V_{OUT}(s)+1.0V}{\Delta T_a \bullet V_{OUT}} $ $ \frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT}} $	Line Regulation		$V_{OUT(S)}$ +1 V ≤ V_{IN} = V_{EN} ≤6 V 1 OUT =1 mA		3	15	mV	
Temperature Stability $\frac{\Delta V_{OUTC}}{\Delta T_A \bullet V_{OUTC}} \left(\begin{array}{c} \text{lout=1mA} \\ -40^{\circ} \le \Gamma_{A} \le 125^{\circ} C \end{array} \right) = \pm 100 \qquad \text{ppm/C}$ Reference Voltage Tolerance $0.686 0.7 0.714 V$ ADJ Pin Current $0.05 0.1 0.2 V$ ADJ Pin Threshold $0.05 0.1 0.2 V$ Enable Turn-On Threshold $0.04 V$ Enable Turn-Off Threshold $0.04 V$ Enable Turn-Off Threshold $0.04 V$ Shutdown Pin Current $0.1 0.5 \mu A$ Shutdown Exit Delay Time $0.1 0.5 \mu A$ Shutdown Exit Delay Time $0.1 0.5 \mu A$ Figood Rise Threshold $0.05 0.1 0.2 V$ PGOOD Rise Threshold $0.05 0.1 0.2 V$ Final Shutdown $0.05 0.1 0.2 V$ $0.1 0.5 \mu A$ $0.1 0.5 \mu A$ $0.1 0.5 \mu A$ $0.1 0.5 \mu A$ $0.2 V 0.1 0.5 \mu A$ $0.3 0 0.5 0.5 0.5$ $0.3 0 0.5 0.5$ $0.4 0.5 0.5 0.5$ $0.5 0.5 0.5$	Load Regulation	ΔV_{OUT2}			15	25	mV	
ADJ Pin Current ADJ Pin Threshold D.05 D.1 D.2 V	Temperature Stability	$\frac{\Delta V_{\rm OUT}}{\Delta T_a \bullet V_{OUT(s)}}$	I _{OUT} =1mA		±100		ppm/℃	
ADJ Pin Threshold Dutput ON 1.6 V	Reference Voltage Tolerance			0.686	0.7	0.714	V	
Enable Turn-On Threshold Output ON 1.6 V	ADJ Pin Current		$V_{ADJ} = V_{REF}$		10		nA	
Enable Turn-Off Threshold Output OFF O.4 V				0.05	0.1	0.2	V	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Enable Turn-On Threshold		Output ON	1.6			V	
Shutdown Exit Delay Time 0			Output OFF				V	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$					0.1	0.5	μΑ	
Resistance to GND during Shutdown PGOOD Rise Threshold PGHTH 90 %					0		μs	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$								
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$					30		Ω	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$								
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$								
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$								
Feature F=1kHz, Iouτ=10mA 61 F=10kHz, Iouτ=10mA 54 54 F=10kHz, Iouτ=10mA 42 61 F=1MHz, Iouτ=10mA 61 61 CBP = 1μF, Vouτ=3.3V f=10Hz 115 μV _{RMS} Thermal Shutdown Temperature Tsp 175 °C		PG _{DLY}						
Power Supply Ripple Rejection $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	PGOOD Sink Capability						V	
Power Supply Ripple Rejection	Power Supply Ripple Rejection							
1-100kHz, 1001-10HA		PSRR					dB	
Output Noise Voltage V_{OUTN} $C_{BP} = 1\mu F, V_{OUT} = 3.3V f = 10Hz$ 115 μV_{RMS} Thermal Shutdown Temperature T_{SD}	. сме. сарріў і арріс і сојосасі.							
Thermal Shutdown Temperature Touth Temperature Tib Tib Tib Tib Tib Tib Tib Tib Tib Ti					61			
Temperature 15D 175	•	Voutn			115		μV _{RMS}	
Thermal Shutdown Hysteresis T _{SD_HYS} 35 °C		T _{SD}			175			
	Thermal Shutdown Hysteresis	T _{SD_HYS}			35		$^{\circ}$ C	

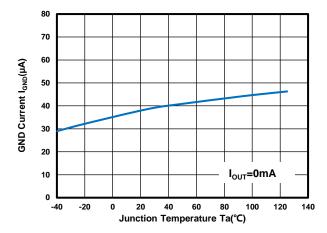
Notes:

- 1. $V_{OUT(S)}$: Output voltage when $V_{IN}=V_{OUT}+1V$, $I_{OUT}=1$ mA.
- $2. \hspace{0.5cm} V_{DROP} = V_{IN1} (V_{OUT(S)} \times 0.98) \hspace{0.5cm} \text{where } V_{IN1} \hspace{0.5cm} \text{is the input voltage when } V_{OUT} = V_{OUT(S)} \times 0.98.$
- 3. ILIM: Output current when VIN=VOUT(S)+1V and VOUT = 0.95*VOUT(S).

TYPICAL PERFORMANCE CHARACTERISTICS

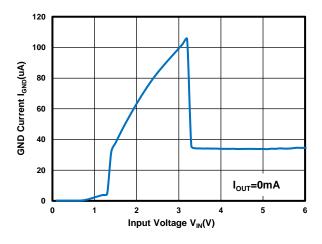
Test Conditions: V_{IN} = V_{OUT} +1.0V, C_{IN} = 4.7 μ F, C_{OUT} = 4.7 μ F, T_A =25 $^{\circ}$ C, unless otherwise indicated.

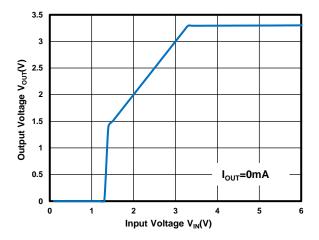




Output Voltage vs. Temperature at Vout=3.3V

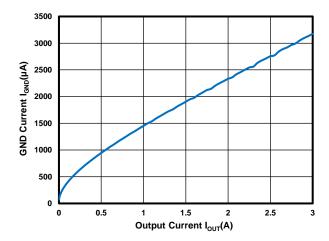
GND Current vs. Temperature at Vout=3.3V

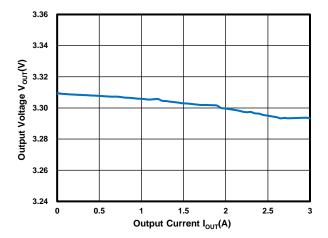




GND Current vs. Input Voltage at Vout=3.3V

Output Voltage vs Input Voltage at Vout=3.3V



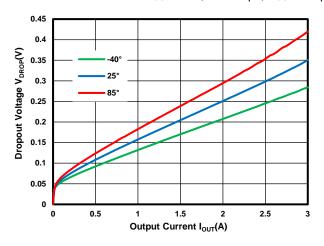


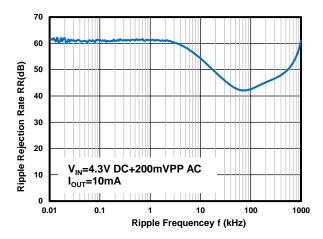
GND Current vs Output Current at Vout=3.3V

Output Voltage vs Output Current at Vout=3.3V

TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED)

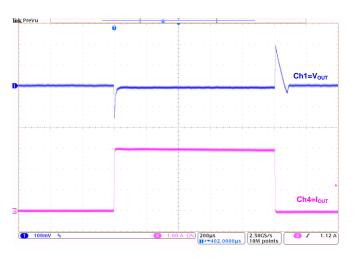
Test Conditions: V_{IN} = V_{OUT} +1.0V, C_{IN} =4.7 μ F, C_{OUT} = 4.7 μ F, T_A =25 $^{\circ}$ C, unless otherwise indicated.

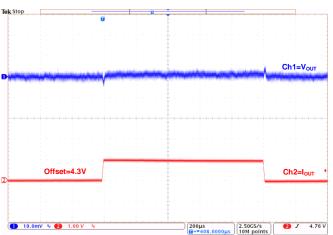




Dropout Voltage vs. Output Current at Vout=3.3V

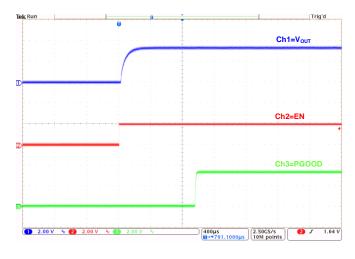
Power Supply Rejection Ratio at Vout=3.3V

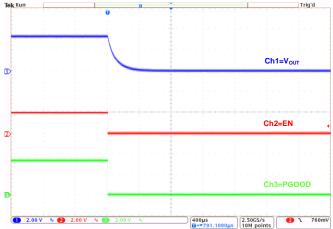




Load Transient at V_{OUT}=3.3V (I_{OUT}=10mA~3A~10mA)

Line Transient at V_{OUT}=3.3V (I_{OUT}=10mA)



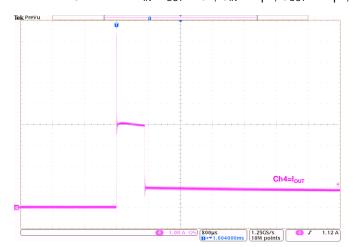


Enable Startup at V_{OUT}=3.3V (I_{OUT}=0mA)

Enable Shutdown at V_{OUT}=3.3V (I_{OUT}=0mA)

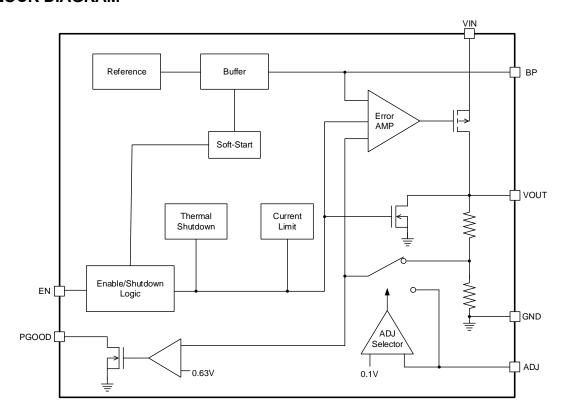
TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED)

Test Conditions: $V_{IN}=V_{OUT}+1.0V$, $C_{IN}=4.7\mu F$, $C_{OUT}=4.7\mu F$, $T_A=25\,^{\circ}\mathrm{C}$, unless otherwise indicated.



Output Current Fold-back at Vout=3.3V

BLOCK DIAGRAM



THEORY OF OPERATION

The MD7673 is a low-dropout voltage regulator with low quiescent current, low noise and high PSRR. It can support load current up to 3A. It incorporates current-limit and thermal protection features.

SHUTDOWN

By connecting EN pin to GND, the MD7673 can be shutdown to reduce the supply current to $0.01\mu A$ (typ.). In this mode, the output voltage of MD7673 is equal to 0V.

CURRENT LIMIT and SHORT CIRCUIT PROTECTION

The MD7673 includes current limit protection feature, which monitors and controls the maximum output current. If the output is overloaded or shorted to ground, this can protect the device from being damaged. When output is shorted to ground, current limit will be adjusted to about 25% of the rated current limit to protect the device.

THERMAL PROTECTION

The MD7673 includes a thermal protection feature that protects the IC by turning off the pass transistor when the maximum junction temperature T_J exceed 175℃.

POWER DISSIPATION

The power dissipation across the device can be calculated as:

$$P_{D} = I_{OUT} * (V_{IN} - V_{OUT})$$

The total junction temperature is calculated as:

$$T_{J} = T_{A} + (P_{D} * \theta_{JA})$$

where, T_J is the junction temperature, T_A is the ambient temperature and θ_{JA} is the thermal resistance between junction to ambient. There is a temperature rise associated with this power dissipated while operating in a given ambient temperature. If the calculated junction temperature exceeds maximum junction temperature specification, then the built-in thermal protection feature is triggered as described previously. To insure reliable performance, the maximum allowable power dissipation for a given ambient temperature must be considered and it can be calculated as follows:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$$

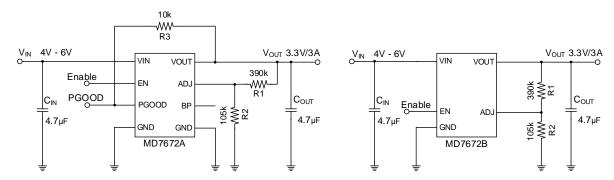
where, $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature and θ_{JA} is the thermal resistance between junction to ambient. In order to insure the best thermal flow, proper mounting of the IC is required.

INPUT & OUTPUT CAPACITORS

MD7673 is optimized for use with ceramic capacitors. In order to ensure stability of the device, please place an output ceramic capacitor of $4.7\mu F$ or bigger at the V_{OUT} pin and GND pin as close as possible. An input capacitor of $4.7\mu F$ is recommended. X5R or X7R ceramic capacitors are recommended as they have the best temperature and voltage characteristics. If the impedance of the power supply is high, which is caused by forgetting installing input capacitor or installing too small value capacitor, the oscillation may occur.

When large output current switching (>500mA) are required in the application, a greater value of input/output capacitors (\geq 10 µF) would be recommended to ensure the device to operate smoothly.

TYPICAL APPLICATION SCHEMATIC



PROGRAMMING THE OUTPUT VOLTAGE

MD7673's internal feedback resistors set the output voltage V_{OUT} to 5V when the ADJ pin is connected to GND. Alternatively; the output voltage is adjustable via the external feedback resistor network R1 and R2 by calculating the following formula:

$$V_{OUT} = V_{REF} * (1 + \frac{R1}{R2})$$

where, V_{REF} is the reference voltage set internally at 0.7V nominal.

NOISE BYPASS CAPACITOR (For MD7673A)

A $1\mu F$ bypass capacitor at BP pin can reduce output voltage noise. This pin can be left floating if it is unnecessary. **POWER-GOOD FUNCTION**

The power-good circuit monitors the voltage at the feedback pin to indicate the status of the output voltage. When the output voltage falls below the PGOOD fall threshold voltage (PG_{LTH}), the PGOOD pin open-drain output engages and pulls the PGOOD pin close to GND. When the output voltage exceeds PGOOD rise threshold voltage (PG_{HTH}), the PGOOD pin becomes high impedance. By connecting a pullup resistor to external pullup supply voltage (default for V_{OUT}), any downstream device can receive power-good as a logic signal that can be used for sequencing. Make sure that the external pullup supply voltage results in a valid logic signal for the receiving device. Using a pullup resistor from 10 k Ω to 100 k Ω is recommended.

LAYOUT CONSIDERATION

- 1. Connect the bottom-side pad to a large ground plane for good thermal conductivity and to reduce the thermal resistance of the device.
- 2. The input Capacitor C_{IN} and output capacitor C_{OUT} must be placed as close as possible to the pins V_{IN} and V_{OUT} respectively.
- 3. Use short wires to connect the power supply to pins V_{IN} and GND on the board.

Notes on Use

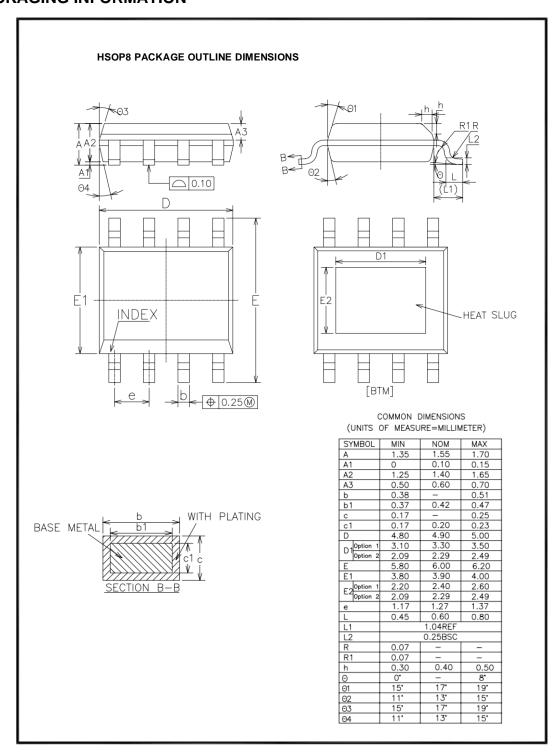
- 1. The input capacitor (C_{IN}) and the output capacitor (C_{OUT}) should be placed to the as close as possible with a shorter wiring.
- 2. If the impedance of the power supply is high, which is caused by forgetting installing input capacitor or installing too small value capacitor, the oscillation may occur.
- 3. Please pay attention to the operation conditions of input and output voltage and load current, such that the power consumption in the IC should not exceed the allowable power consumption of the package even though the chip has short circuit protection.

IC has a built-in anti-static protection (ESD) circuit, but please do not add excessive stress to the IC.

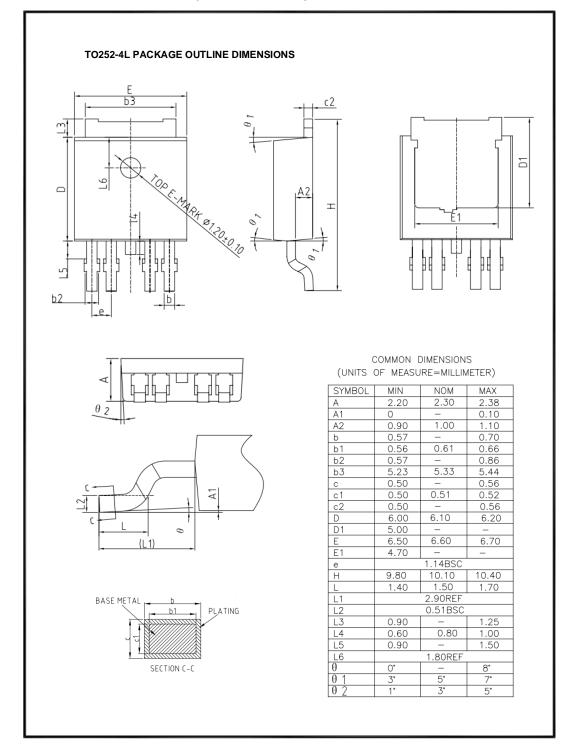
Ordering Information

Part Name	Package	Marking	Packing quantity	
MD7673A50SF4	HSOP8	№ 7673A	4000/ Tape & Reel	
MD7673B50SF4	HSOP8	№ 7673B	4000/ Tape & Reel	All packages are
MD7673E50UB2	TO252-4L	№ 7673	2500/ Tape & Reel	lead-free
MD7673E50VC1	TO263-5L	№ 7673	800/ Tape & Reel	

PACKAGING INFORMATION



PACKAGING INFORMATION(CONTINUTED)



For the newest datasheet, please see the website:

Version V0.9: 20200528

www.md-ic.com.cn